

FEATURES

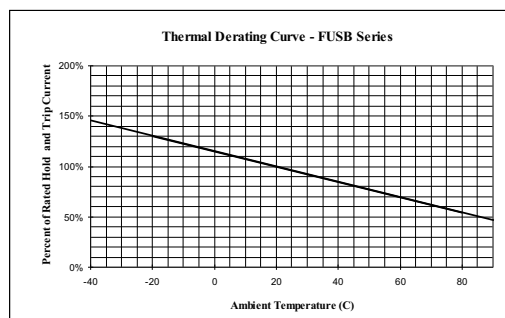
- Applications : Low voltage USB equipment and computers & Peripherals
- Product Features : Low resistance, Fast trip time, Low trip-to-hold ratio
- Operation Current: 0.75A ~ 2.50A
- Maximum Voltage: 16V/30Vdc
- Temperature Range: -40°C to 85°C

AGENCY RECOGNITION

Made for RFE by UL shop Fuzetec

- UL (E211981)
- C-UL (E211981)
- TÜV (R50004084)

THERMAL DERATING CURVE



ELECTRICAL CHARACTERISTICS (23°C)

Part Number	Hold Current	Trip Current	Max. Time to Trip		Maximum Current	Rated Voltage	Typical Power	Resistance	
			Current	Time				R min	R1 max
			I _H , A	I _T , A				A	Sec
FUSB075F	0.75	1.30	8.0	0.4	40	16	0.3	0.08	0.23
FUSB090F	0.90	1.80	8.0	1.2	40	16/30	0.6	0.07	0.18
FUSB110F	1.10	2.20	8.0	2.3	40	16/30	0.7	0.05	0.14
FUSB120F	1.20	2.00	8.0	0.7	40	16	0.6	0.04	0.14
FUSB135F	1.35	2.70	8.0	4.5	40	16/30	0.8	0.04	0.12
FUSB155F	1.55	2.70	7.8	2.2	40	16	0.7	0.03	0.12
FUSB160F	1.60	3.20	8.0	9.0	40	16/30	0.9	0.03	0.11
FUSB185F	1.85	3.70	8.0	10.0	40	16/30	1.0	0.03	0.09
FUSB250F	2.50	5.00	8.0	40.0	40	16/30	1.2	0.02	0.07

I_H=Hold current-maximum current at which the device will not trip at 23°C still air.
 I_T=Trip current-maximum current at which the device will always trip at 23°C still air.
 V_{MAX}=Maximum voltage device can withstand without damage at its rated current.
 I_{MAX}=Maximum fault current device can withstand without damage at rated voltage (V_{MAX}).
 Pd=Typical power dissipated from device when in the tripped state in 23°C still air environment.
 R_{MIN}=Minimum device resistance at 23°C.
 R1_{MAX}=Maximum device resistance at 23°C, 1 hour after tripping.

Physical specifications:
 Lead material: Tin plated copper, 24 AWG.
 Soldering characteristics: Solder ability per ANSI/J-STD 002
 Solder heat withstand per IEC68-2-20
 Insulating coating: Flame retardant epoxy, meet UL-94V-0 requirement.

NOTE: All Specifications subject to change without notice.

DIMENSIONS (mm)

Fig. 1
Lead Size: 24AWG
φ 0.51 mm Diameter

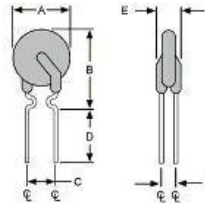
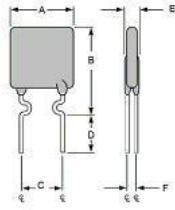
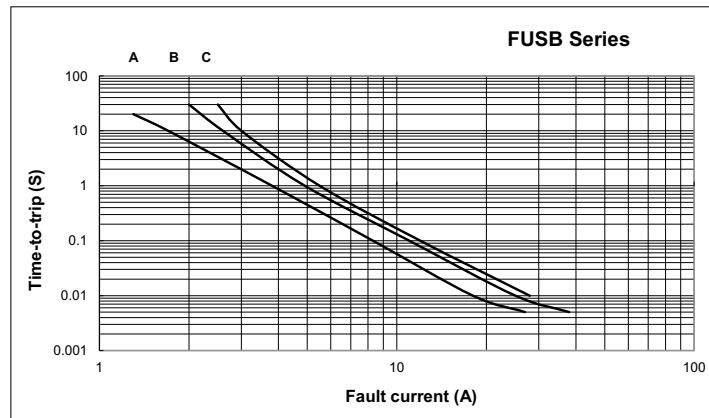


Fig. 2
Lead Size: 24AWG
φ 0.51 mm Diameter

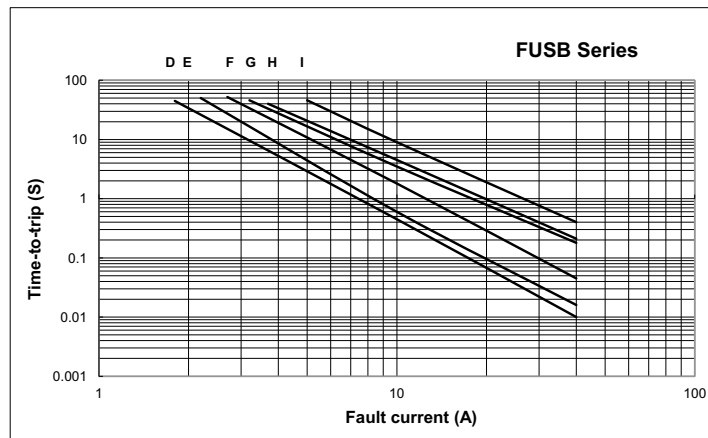
Part Number	Fig.	A	B	C	D	E	F
		Maximum	Maximum	Typical	Minimum	Maximum	Typical
FUSB075F	2	6.9	11.4	5.1	7.6	3.0	0.8
FUSB090F	1	7.4	12.2	5.1	7.6	3.0	0.8
FUSB110F	1	7.4	14.2	5.1	7.6	3.0	0.8
FUSB120F	2	6.9	11.7	5.1	7.6	3.0	0.8
FUSB135F	1	8.9	13.5	5.1	7.6	3.0	0.8
FUSB155F	2	6.9	11.7	5.1	7.6	3.0	0.8
FUSB160F	1	8.9	15.2	5.1	7.6	3.0	0.8
FUSB185F	1	10.2	15.7	5.1	7.6	3.0	0.8
FUSB250F	1	11.4	18.3	5.1	7.6	3.0	0.8

TYPICAL TIME-TO-TRIP AT 23°C

A = FUSB075F
B = FUSB120F
C = FUSB155F



D = FUSB090F
E = FUSB110F
F = FUSB135F
G = FUSB160F
H = FUSB185F
I = FUSB250F



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